



Home Products Quick Quote My Parts List Site Map Contact Us



EQTG32 Series Oscillator

Temperature Compensated Quartz Crystal Clock Oscillators TCXO LVPECL (PECL) 2.5Vdc 6 Pad 2.5mm x 3.2mm Ceramic Surface Mount (SMD)



Revision A 09/09/2015

Electrical Specifications

Nominal Frequency	10.000MHz to 625.000MHz <i>Some frequencies within this range may not be available.</i>
Frequency Stability	Inclusive of Operating Temperature Range, at $V_{DD}=2.5V_{DC}$ ± 5.0 ppm Maximum ± 3.0 ppm Maximum ± 2.5 ppm Maximum ± 2.0 ppm Maximum ± 1.5 ppm Maximum ± 1.0 ppm Maximum
Frequency Stability vs. Frequency Tolerance	At $25^{\circ}C \pm 2^{\circ}C$, at $V_{DD}=2.5V_{DC}$ Pre-Reflow ± 2.0 ppm Maximum ± 1.5 ppm Maximum ± 1.0 ppm Maximum
Frequency Stability vs. Input Voltage	± 0.2 ppm Maximum ($\pm 5\%$)
Frequency Stability vs. Load	± 0.2 ppm Maximum ($\pm 2pF$)
Frequency Stability vs. Reflow	± 1.0 ppm Maximum (at $25^{\circ}C$, 24 hours after reflow, 1 time)
Frequency Stability vs. Aging	± 1 ppm/Year Maximum (at $25^{\circ}C$)
Operating Temperature Range	$0^{\circ}C$ to $+50^{\circ}C$ $-10^{\circ}C$ to $+60^{\circ}C$ $0^{\circ}C$ to $+70^{\circ}C$ $-20^{\circ}C$ to $+70^{\circ}C$ $-30^{\circ}C$ to $+60^{\circ}C$ $-30^{\circ}C$ to $+75^{\circ}C$ $-30^{\circ}C$ to $+85^{\circ}C$ $-40^{\circ}C$ to $+85^{\circ}C$
Supply Voltage	$2.5V_{DC} \pm 5\%$
Input Current	75mA Maximum
Output Voltage Logic High (Voh)	$V_{DD} - 1.025V_{DC}$ Minimum, $1.6V_{DC}$ Typical, $V_{DD} - 0.6V_{DC}$ Maximum
Output Voltage Logic Low (Vol)	$V_{DD} - 1.85V_{DC}$ Minimum, $0.8V_{DC}$ Typical, $V_{DD} - 1.62V_{DC}$ Maximum
Rise/Fall Time	Measured at 10% to 90% of Waveform 300pSec Maximum
Duty Cycle	Measured at 50% of Waveform $50 \pm 5(\%)$
Load Drive Capability	50 Ohms into $V_{DD} - 2V_{DC}$
Output Logic Type	LVPECL

Phase Noise	Click to Open Phase Noise Table
Output Control Function	Output Enable (OE)
Output Control Input Voltage Logic High (Vih)	90% of V_{DD} Minimum or No Connect to Enable Output and Complementary Output
Output Control Input Voltage Logic Low (Vil)	10% of V_{DD} Maximum to Disable Output and Complementary Output (High Impedance)
Output Enable Time	100nSec Maximum
Output Disable Time	50nSec Maximum
Output Enable Current	Without Load (Pin 2 = Ground) 15mA Maximum
RMS Phase Jitter	Click to Open RMS Phase Jitter Table
Period Jitter (Deterministic)	0.2pSec Typical
Period Jitter (Random)	2pSec Typical
Period Jitter (RMS)	3pSec Maximum
Period Jitter (pk-pk)	30pSec Maximum
Start Up Time	10mSec Maximum
Storage Temperature Range	-55°C to +125°C

Phase Noise

All Values are Typical

Nominal Frequency: 10MHz to 50MHz

<i>Offset</i>	<i>Phase Noise</i>
10Hz	-64dBc/Hz
100Hz	-96dBc/Hz
1kHz	-124dBc/Hz
10kHz	-131dBc/Hz
100kHz	-132dBc/Hz
1MHz	-149dBc/Hz
10MHz	-157dBc/Hz
20MHz	-159dBc/Hz

Nominal Frequency: 50.000001MHz to 100MHz

<i>Offset</i>	<i>Phase Noise</i>
10Hz	-58dBc/Hz
100Hz	-90dBc/Hz
1kHz	-118dBc/Hz
10kHz	-125dBc/Hz
100kHz	-126dBc/Hz
1MHz	-145dBc/Hz
10MHz	-155dBc/Hz
20MHz	-157dBc/Hz

Nominal Frequency: 100.000001MHz to 156.249999MHz

<i>Offset</i>	<i>Phase Noise</i>
10Hz	-57dBc/Hz
100Hz	-86dBc/Hz
1kHz	-114dBc/Hz
10kHz	-121dBc/Hz
100kHz	-122dBc/Hz
1MHz	-141dBc/Hz
10MHz	-151dBc/Hz
20MHz	-153dBc/Hz

Nominal Frequency: 156.25MHz to 212.5MHz

<i>Offset</i>	<i>Phase Noise</i>
10Hz	-58dBc/Hz
100Hz	-86dBc/Hz
1kHz	-110dBc/Hz
10kHz	-116dBc/Hz
100kHz	-117dBc/Hz
1MHz	-136dBc/Hz
10MHz	-146dBc/Hz
20MHz	-148dBc/Hz

Nominal Frequency: 212.500001MHz to 500MHz

<i>Offset</i>	<i>Phase Noise</i>
10Hz	-56dBc/Hz
100Hz	-95dBc/Hz

1kHz	-100dBc/Hz
10kHz	-106dBc/Hz
100kHz	-107dBc/Hz
1MHz	-126dBc/Hz
10MHz	-136dBc/Hz
20MHz	-137dBc/Hz

Nominal Frequency: 500.000001MHz to 625MHz

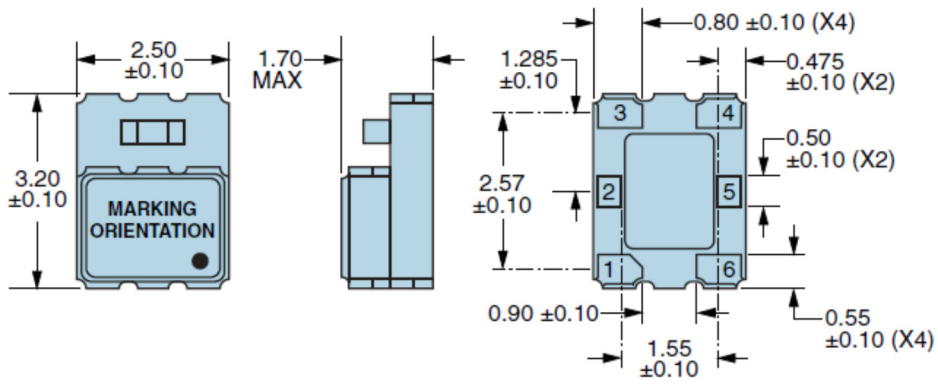
<i>Offset</i>	<i>Phase Noise</i>
10Hz	-54dBc/Hz
100Hz	-84dBc/Hz
1kHz	-97dBc/Hz
10kHz	-104dBc/Hz
100kHz	-105dBc/Hz
1MHz	-124dBc/Hz
10MHz	-134dBc/Hz
20MHz	-136dBc/Hz

RMS Phase Jitter

Fj=12kHz to 20MHz (Random)

<i>Nominal Frequency Range</i>	<i>RMS Phase Jitter</i>
10MHz to 50MHz	1.5pSec Maximum
50.000001MHz to 100MHz	1.4pSec Maximum
100.000001MHz to 625MHz	1.3pSec Maximum

Mechanical Dimensions



Terminal Plating Thickness: Gold (0.3 to 1.0 μ m) over Nickel (1.27 to 8.89 μ m).

All Dimensions in Millimeters

Pin 1: Do Not Connect

Pin 2: Output Enable (OE)

Pin 3: Case/Ground

Pin 4: Output

Pin 5: Complementary Output

Pin 6: Supply Voltage

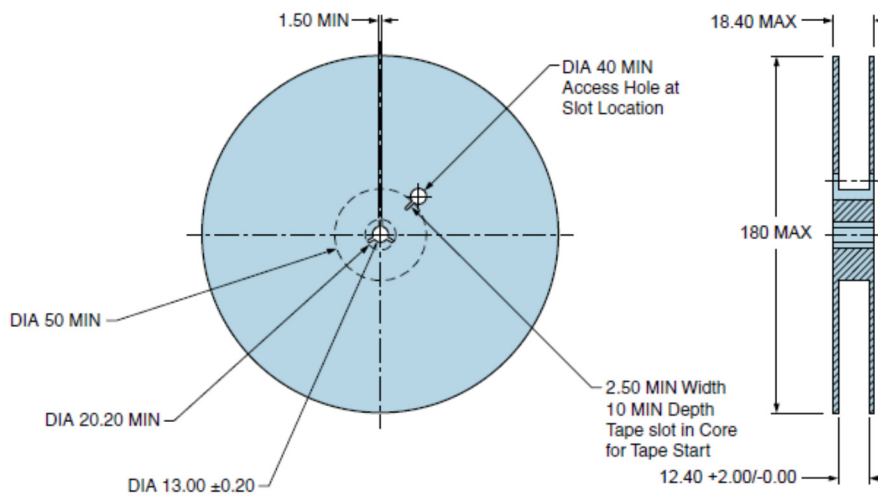
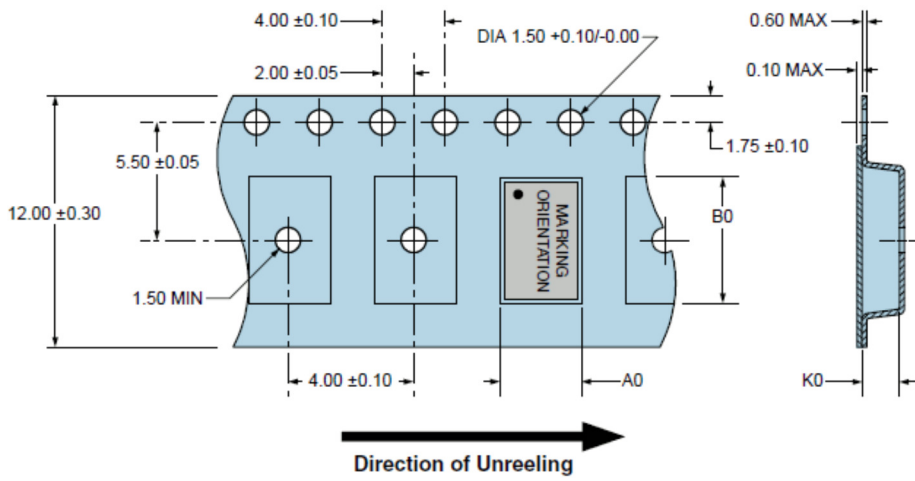
Marking Specifications

- Line 1: **EXXXXXX**
- E = Ecliptek Designator
 - XXXXXX = Nominal Frequency in MHz (5 digits + Decimal)
- Line 2: **XXXXXX**
- XXXXXX = Ecliptek Manufacturing Identifier

Environmental and Mechanical Specifications

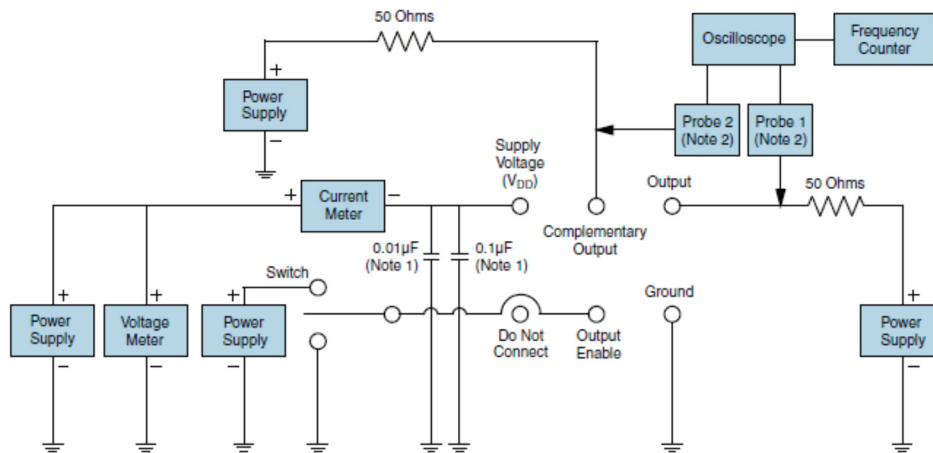
ESD Susceptibility	MIL-STD-883, Method 3015, Class 1, HBM: 1500V
Fine Leak Test	MIL-STD-883, Method 1014, Condition A
Flammability	UL94-V0
Gross Leak Test	MIL-STD-883, Method 1014, Condition C
Mechanical Shock	MIL-STD-883, Method 2002, Condition B
Moisture Resistance	MIL-STD-883, Method 1004
Moisture Sensitivity	J-STD-020, MSL 1
Resistance to Soldering Heat	MIL-STD-202, Method 210, Condition K
Resistance to Solvents	MIL-STD-202, Method 215
Solderability	MIL-STD-883, Method 2003
Temperature Cycling	MIL-STD-883, Method 1010, Condition B
Vibration	MIL-STD-883, Method 2007, Condition A
Thermal Resistance (θ_{JA})	45°C/W (degrees Celsius per Watt)
Thermal Resistance (θ_{JC})	19°C/W (degrees Celsius per Watt)

Tape & Reel Dimensions



1000 pieces per reel
 Compliant to EIA-481
 All Dimensions in Millimeters

Test Circuit for PECL Output

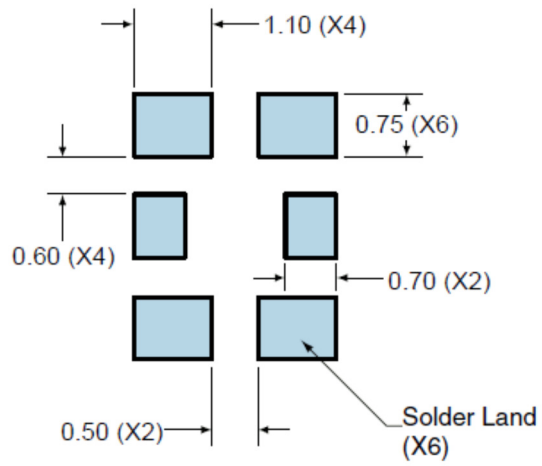


Note 1: An external 0.01μF ceramic bypass capacitor in parallel with a 0.1μF high frequency ceramic bypass capacitor close (less than 2mm) to the package ground and supply voltage pin is required.

Note 2: A low input capacitance (<12pF), 10X attenuation factor, high impedance (>10Mohms), and high bandwidth (>500MHz) passive probe is recommended.

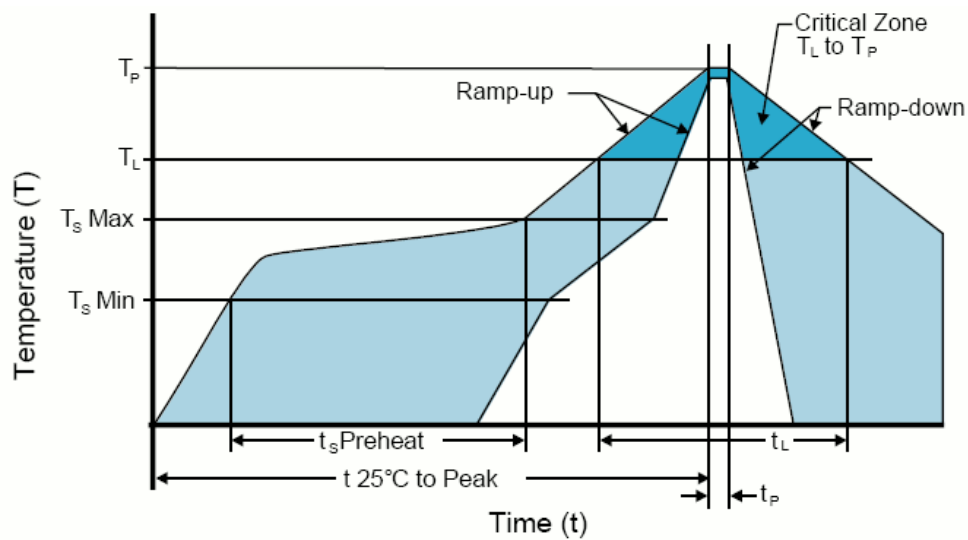
Note 3: Test circuit PCB traces need to be designed for a characteristic line impedance of 50 ohms.

Recommended Solder Pad Dimensions



Tolerances = ± 0.1
All Dimensions in Millimeters

Solder Reflow Profile



High Temperature Infrared/Convection

Note: Temperatures shown are applied to body of device.

T_s MAX to T_L (Ramp-up Rate)	3°C/Second Maximum
Preheat	
- Temperature Minimum (T_s MIN)	150°C
- Temperature Typical (T_s TYP)	175°C
- Temperature Maximum (T_s MAX)	200°C
- Time (t_s)	60 - 180 Seconds
Ramp-up Rate (T_L to T_p)	3°C/Second Maximum
Time Maintained Above:	
- Temperature (T_L)	217°C
- Time (t_L)	60 - 150 Seconds
Peak Temperature (T_p)	260°C Maximum for 10 Seconds Maximum
Target Peak Temperature (T_p Target)	250°C +0/-5°C
Time within 5°C of actual peak (t_p)	20 - 40 Seconds
Ramp-down Rate	6°C/Second Maximum
Time 25°C to Peak Temperature (t)	8 Minutes Maximum
Moisture Sensitivity Level	Level 1

Low Temperature Infrared/Convection 240°C

Note: Temperatures shown are applied to body of device.

T_S MAX to T_L (Ramp-up Rate)	5°C/Second Maximum
Preheat	
- Temperature Minimum (T_S MIN)	N/A
- Temperature Typical (T_S TYP)	150°C
- Temperature Maximum (T_S MAX)	N/A
- Time (t_S)	60 - 120 Seconds
Ramp-up Rate (T_L to T_p)	5°C/Second Maximum
Time Maintained Above:	
- Temperature (T_L)	150°C
- Time (t_L)	200 Seconds Maximum
Peak Temperature (T_p)	240°C Maximum
Target Peak Temperature (T_p Target)	240°C Maximum 2 Times / 230°C Maximum 1 Time
Time within 5°C of actual peak (t_p)	10 Seconds Maximum 2 Times / 80 Seconds Maximum 1 Time
Ramp-down Rate	5°C/Second Maximum
Time 25°C to Peak Temperature (t)	N/A
Moisture Sensitivity Level	Level 1

High Temperature Manual Soldering

Note: Temperatures shown are applied to body of device.
260°C Maximum for 5 Seconds Maximum, 2 times Maximum.

Low Temperature Manual Soldering

Note: Temperatures shown are applied to body of device.
185°C Maximum for 10 Seconds Maximum, 2 times Maximum.

1 - Build A Part Number

Select the parameters that meet your requirements and then click Next

Frequency in Megahertz (10 to 625):
Some frequencies within this range may not be available

Frequency Stability vs. Frequency Tolerance:

Operating Temperature Range:







Frequency Stability:

Packaging Options:

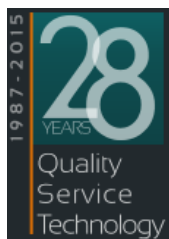
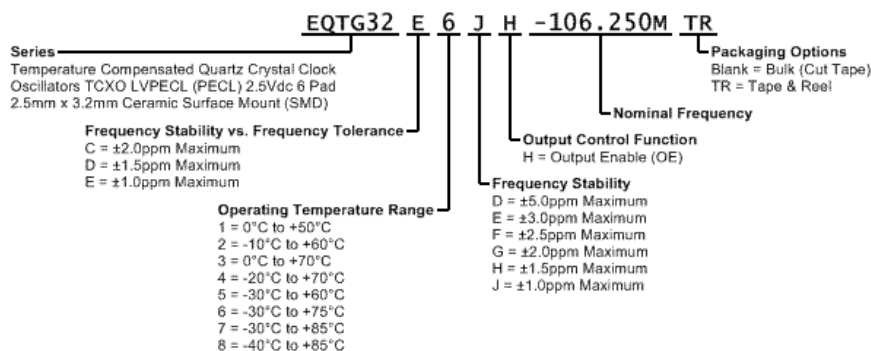
 Next

2 - Next Page

Access these Part Number specific resources and tools

-  [P/N Specific Data Sheet](#)
-  [Automated Quick Quote](#)
-  [Request Sample](#)
-  [Download IPC-1752](#)
-  [My Parts List ?](#)
-  [My Part Number ?](#)

Part Numbering Guide



TOOLS

- [Quick Quote](#)
- [SmartSearch](#)
- [Compliance Documents](#)
- [Chipset Cross Reference](#)
- [Competitor Cross Reference](#)

PRODUCT

- [Crystals](#)
- [Oscillators](#)
- [Part Search](#)
- [REACH Resources](#)
- [RoHS Resources](#)
- [End of Life](#)

ECLIPTEK

- [Authorized Distributors](#)
- [Contact](#)
- [About](#)
- [News](#)
- [Our Quality](#)
- [ISO9001](#)
- [Feedback](#)

TERMS

- [Privacy Policy](#)
- [Terms of Sale](#)
- [Legal](#)